

## **1.0-A Single-Input, Single-Cell Li-Ion Battery Charger**

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This user's guide describes the bq24090/1/2/3 evaluation module (EVM), how to perform a stand-alone evaluation or interface with a host or system. The charger is designed to deliver up to 1000mA of continuous current to the battery output when programmed with a resistor on the ISET pin and is programmed at the factory for ~540mA. The USB current limit modes are selected by the ISET2 pin and limits current to a maximum of 500mA (logic high) or 100mA (float or high impedance). A low on the ISET2 pin programs the charge current using the ISET resistor.

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## 1 Introduction

The bq24090/1/2/3 series of devices are highly integrated Li-ion linear charger devices targeted at space-limited portable applications. The devices operate from either a USB port or AC adapter.

The bq24090/1/2/3 has a single power output that charges the battery. A system load can be placed in parallel with the battery as long as the average system load does not keep the battery from charging fully during the 10 hour safety timer.

The battery is charged in three phases: conditioning, constant current, and constant voltage. In all charge phases, an internal control loop monitors the IC junction temperature and reduces the charge current if an internal temperature threshold is exceeded.

The charger power stage and charge current sense functions are fully integrated. The charger function has high-accuracy current and voltage regulation loops, charge status display, and charge termination. The pre-charge current and termination current threshold are programmed via an external resistor on the bq24090/1/2/3. The fast charge current value is also programmable via an external resistor.

## 2 Considerations With Evaluating the bq24090/1/2/3

Refer to the data sheet for specific details on the charger ICs. The main differences between the bq24090, at 25° and bq24091 is that NTC thermistor value is 10k for bq24090 and 100k for bq24091.

The ISET current control loop sets the maximum charge current. This maximum programmed current level can be further reduced by entering a USB mode, selected by the ISET2 pin.

A system load may be connected to the OUT pin, which takes away some of the charge current. Normally it is not recommended to operate the device in pre-charge since the system load keeps the battery from recovering; but, since the PRE\_TERM pin can program a higher pre-charge current this restriction is not necessary.

## 3 Performance Specification Summary

Specification	Test Conditions	MIN	TYP	MAX	UNIT
Input DC voltage, Vin	Recommended input voltage range	4.45		6.45	V
Reduced Performance, Vin <sup>(1)</sup>	Will not charge with Over Voltage input condition. Limited charging with under voltage input.	3.5		28	V
Power Dissipation <sup>(2)</sup>	$P_{DISS} = (V_{IN} - V_{OUT}) \times I_{OUT}$			1.5	W
I <sub>OUT</sub>	RISSET = 1k		0.54	0.8	A

<sup>(1)</sup> Input voltage range is specified for normal operation. Input voltage between UVLO and 4.75 V has limited functionality, but does not damage the IC nor present any safety issue with the battery. Input voltage above OVP and less than 30 Vdc has no operation and will not damage the IC. Lower input voltage (closer to dropout operation) produces less heat dissipation and potentially better performance.

<sup>(2)</sup> The junction temperature rise above ambient is proportional to the power dissipation. Once the junction temperature reaches ~125°C, thermal regulation reduces the programmed charge current.

## 4 Test Summary

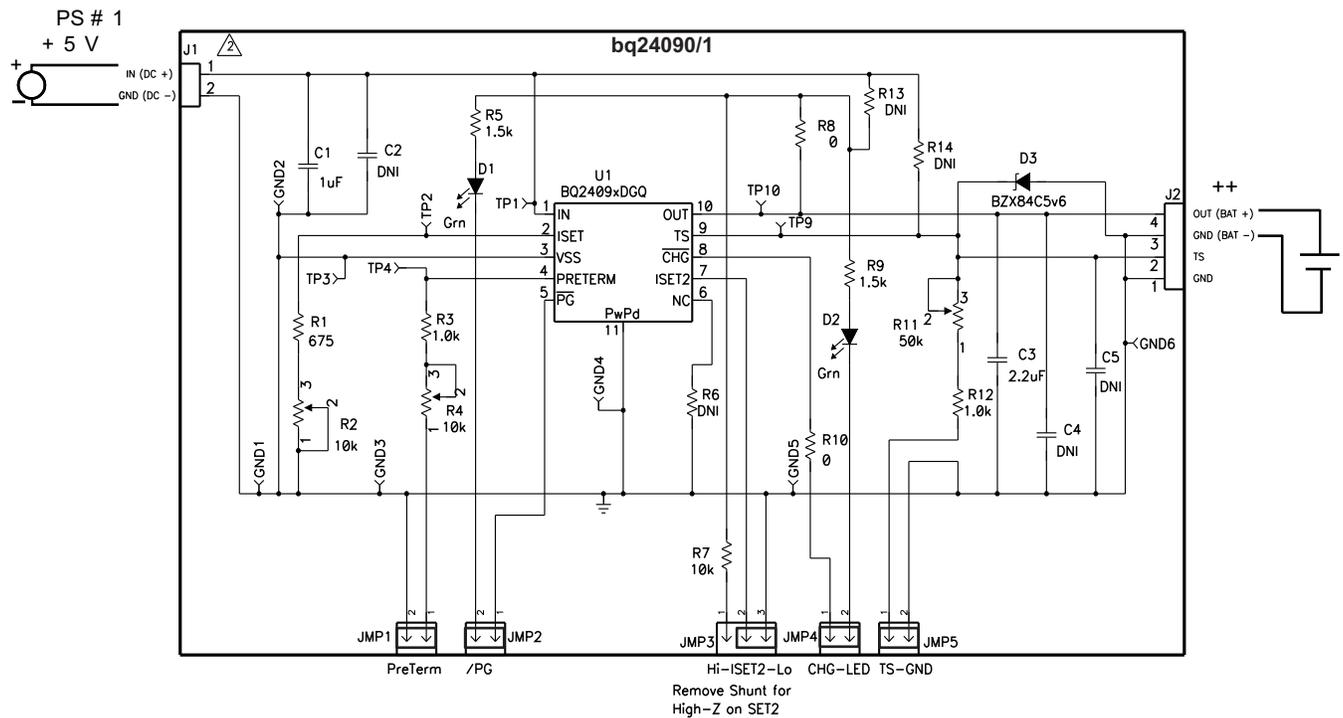
The bq24090/1/2/3 EVM board requires a 5-VDC, 1-A power source to provide input power and a single-cell Li-ion or Li-polymer battery pack. The test setup connections and jumper setting selections are configured for a stand-alone evaluation; but, can be changed to interface with external hardware such as a microcontroller.

### 4.1 Equipment

- Power supply +5.1 ±0.1 V, current limit set to 1.5 ±0.1 A
- Battery: 4.2 V LiCoO<sub>2</sub> or equivalent
- Three Fluke 75 DMMs (equivalent or better)
- Oscilloscope, Model TDS220 (equivalent or better)

### 4.2 Equipment and EVM Setup

Jack/Component	Connect or Adjustment To:
J1-DC+	Power supply positive, preset to 5 VDC, 1-A current limit.
J1-DC-	Power supply ground
J2-BAT+	Positive Battery Pack Terminal
J2-BAT-	Negative Battery Pack Terminal
JMP1	Apply shunt for Pre-TERM connection.
JMP2	Apply shunt for PG LED connection.
JMP3	Apply shunt for ISET2: ISET2-LO (pins 2-3) connection.
JMP4	Apply shunt for CHG LED connection.
JMP5	Apply shunt for TS connection.
R2 (R <sub>ISET</sub> )	Adjust R2 for 1k between TP2 and GND
R3 (R <sub>PRE-TERM</sub> )	Adjust R4 for 2k between TP4 and GND
R11 (R <sub>TS</sub> )	Adjust R11 for 10k between TP9 and GND



**Figure 1. EVM Setup**

### 4.3 Test Procedure Using a Single Cell Li-Ion Battery

1. Verify that the setup is correct and turn on the power supply, which was preset to 5 VDC, and 1 A for the current-limit setting.
2. The bq24090/1/2/3 enters preconditioning mode if the battery is below the  $V_{(LOWV)}$  threshold. In this mode, the bq24090/1/2/3 pre-charges the battery with a low current programmed by the PRE-TERM resistor (typically set to 10% of fast charge) until the battery voltage reaches the  $V_{(LOWV)}$  threshold or until the pre-charge timer expires. If the timer expires, then the charge current is terminated and the bq24090/1/2/3 enters fault mode. The CHG LED turns off when in timer fault mode. Toggling input power, toggling TS (BAT\_EN) or battery replacement resets fault mode.
3. When the battery voltage rises above the  $V_{(LOWV)}$  threshold, the battery enters fast-charge constant current mode. This EVM is programmed for 0.54 A of fast-charging current.
4. Remove the shunt from JMP3 and see the IC go into USB100 mode (charge current drops); place shunt between ISET2 and HI and see the USB500 mode; return shunt to ISET2-GND for programmed current.
5.
  - (a) For bq24090/1: Adjust R11 (TS potentiometer) clockwise until the cold fault threshold is reached ( $V_{TS} = \sim 1.4V$ ); note that the charging stops, and the CHG LED STAYS on (for 1st charge only). Adjust R11 until  $V_{TS} \approx 0.5$ ; note that the charging has continued. Continue adjusting R11 until  $V_{TS} \approx 150$  mV; note that charging has stopped due to a high temperature fault and the CHG LED remains on during the first charge. Adjust R11 until  $V_{TS} \approx 0.5V$ .
  - (b) For bq24092/3: Adjust R11 (TS potentiometer) clockwise until the cold operation threshold is reached ( $V_{TS} = \sim 790mV$ ); note that the fast charge current drops to have the amplitude, Continue to adjust R11 until the cold fault threshold is reached ( $V_{TS} = \sim 1.4V$ ); note that the charging stops, and the CHG LED STAYS on (for 1st charge only). Adjust R11 until  $V_{TS} \approx 0.5$ ; note that the charging has continued. Continue adjusting R11 until  $V_{TS} \approx 278$  mV; note that in voltage regulation mode the regulation voltage will be  $\sim 4.06V$ . Continue adjusting R11 until  $V_{TS} \approx 150$  mV; note that charging has stopped due to a high temperature fault and the CHG LED remains on during the first charge. Adjust R11 until  $V_{TS} \approx 0.5V$  and verify that charging continues.
6. Once the battery reaches the voltage regulation threshold (4.2 V), the voltage control loop takes over and the current tapers down as the battery reaches its full capacity.
7. The battery remains at the fast-charge mode until either the charge timer expires or the charge termination current threshold is reached.
8. When the charge terminates, the CHG LED turns off.
9. Remove JMP5 (TS) and the charger turns on. This mode is Termination and Timer Disable Mode (TTDM). This allows continuous power applied from the input to the output, regulated to 4.2V with a maximum current programmed by the ISET resistor (can be restricted further if in USB mode). The system can operate without a battery in this mode as long as the system does not exceed the supplied input current.
10. If the battery discharges to the recharge threshold, the charger starts fast charging, but the CHG LED will not come on for the subsequent charges. Cycling the input power, replacing the battery, or toggling the TS pin low starts a new charge with the CHG LED on.

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**NOTE:** Loads across the battery can affect termination. The pre-term pin can be adjusted to offset the system current. See data sheet for more details.

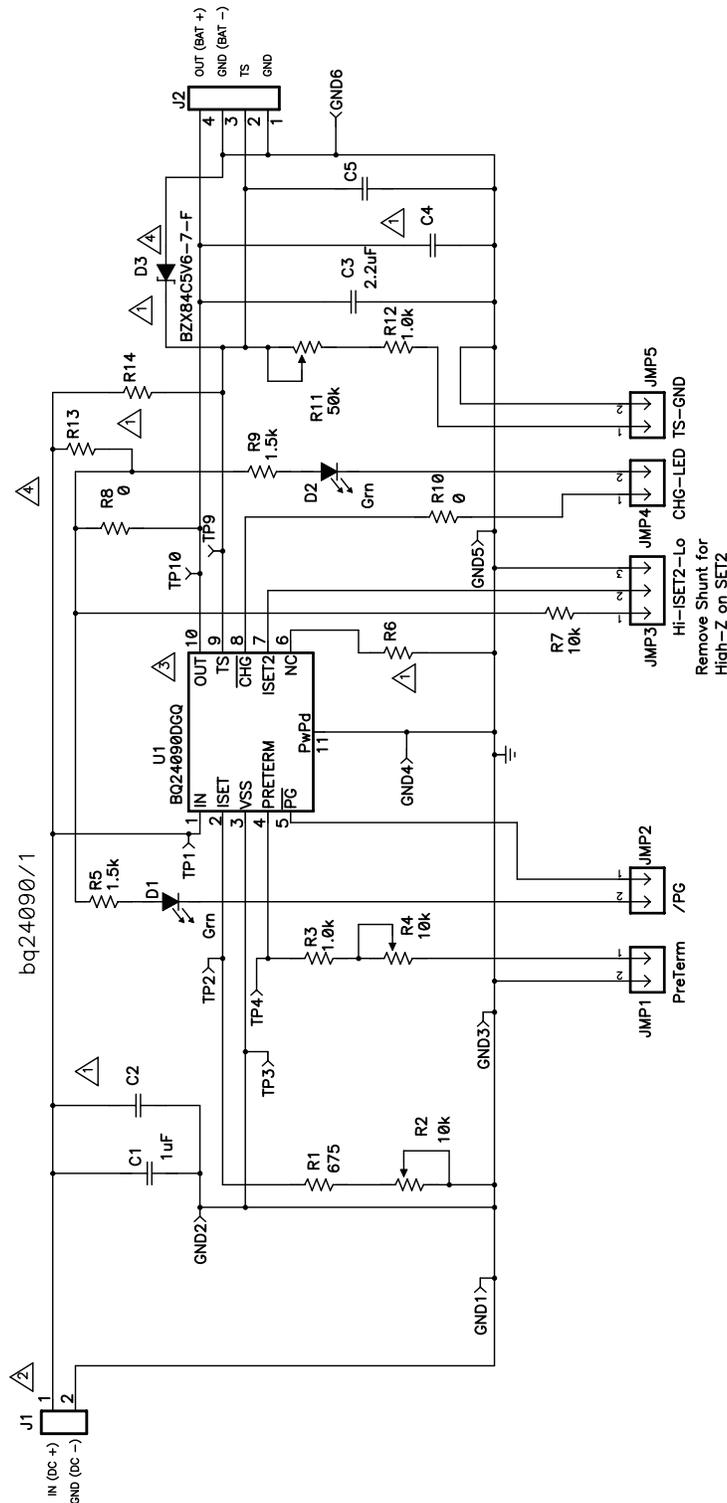
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### 4.4 Alternate Test Methods

A 4-quadrant power supply that can source and sink current can be used in place of the battery pack to evaluate the charger. It allows each transfer between pre-charge, constant-current and constant voltage fast charge. Keep leads short to avoid adding too much inductance which may cause an interaction between the power supply and charger. A large capacitor across the output helps cancel the inductance if long leads are necessary.

## 5 Schematic, Physical Layouts and Bill of Materials

### 5.1 Schematic



⚠ Do not install D3, R6, R13 & R14. C2, C4 and C5 are not installed and can be used for additional capacitance if desired.

⚠ R14 may be used in a future development.

⚠ Input Voltage: 4.5V to 5.5VDC Typical, Consider Thermal Issues for > 5.5V to OVP; No charging above OVP.

⚠ OUT is a 4.2V regulated output with a programmable output current of 1A maximum.

⚠ TP1 → TP10 are associated with U1 pin out. TP5,6,7 & 8 are omitted.

⚠ R8 connects OUTpin pull-up for the LEDs and ISET2. Can move R8 to R13 if Vin is desired as the pull-up source (note Vin should be <7V for this configuration or clamp voltage with D3, if R14 is installed).

Figure 2. bq24090/1/2/3 EVM Board Schematic

## 5.2 Physical Layouts

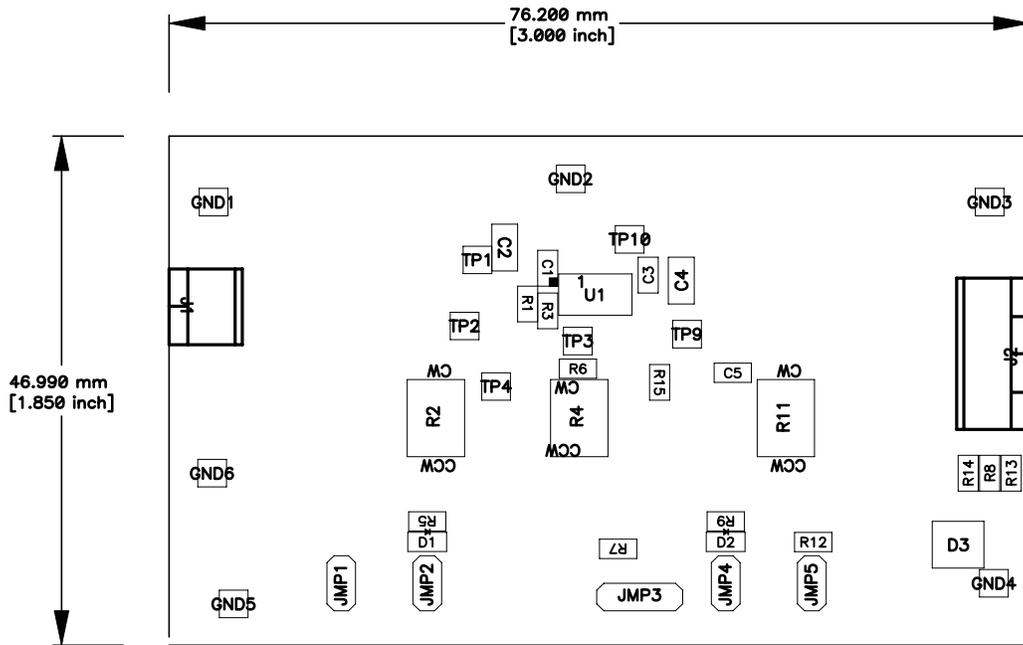


Figure 3. Assembly Layer

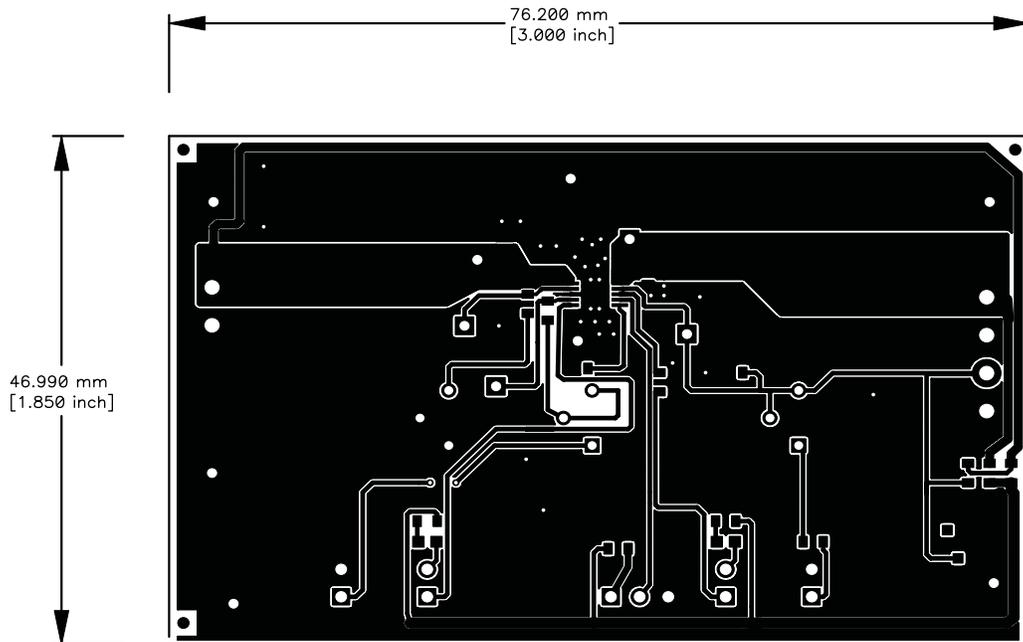


Figure 4. Top Layer

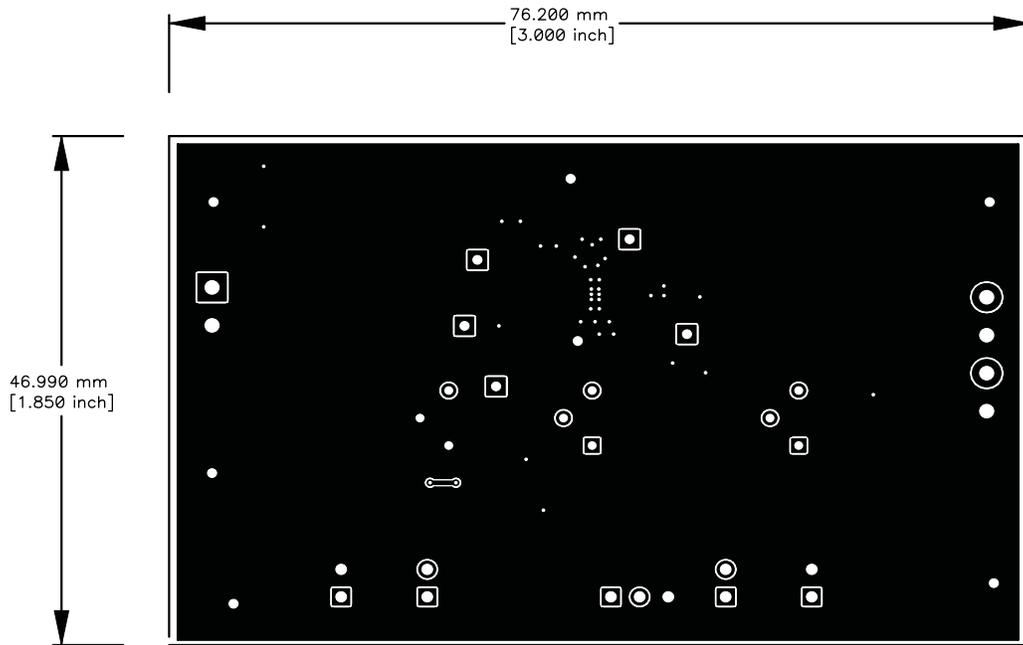


Figure 5. Bottom Layer

### 5.3 Bill of Materials

**Table 1. HPA506B Bill of Materials**

-001	-002	-003	-004	RefDes	Value	Description	Size	Part Number	MFR
1	1	1	1	C1	1 µF	Capacitor, Ceramic, 25V, X5R, 10%	0603	ECJ-1VB1E105K	Panasonic
0	0	0	0	C2		Capacitor, Ceramic, 25V, X5R, 10%	0805	ECJ-2FB1E225K	Panasonic
1	1	1	1	C3	2.2 µF	Capacitor, Ceramic, 10V, X5R, 10%	0603	ECJ-1VB1A225K	Panasonic
0	0	0	0	C4		Capacitor, Ceramic, 10V, X5R, 10%	0805	ECJ-2FB1A106K	Std
0	0	0	0	C5		Capacitor, Ceramic, 10V, X5R, 10%	0603	ECJ-1VB1A225K	Panasonic
2	2	2	2	D1, D2	LTST-C190GKT	Diode, LED, Green, 2.1-V, 20-mA, 6-mcd	0603	LTST-C190GKT	Lite On
0	0	0	0	D3	BZX84C5V6-7-F	Diode, Zener, 5.6-V, 350-mW	SOT-23	BZX84C5V6-7-F	Diodes
1	1	1	1	J1	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	0.27 x 0.25 inch	ED555/2DS	OST
1	1	1	1	J2	ED555/4DS	Terminal Block, 4-pin, 6-A, 3.5mm	0.55 x 0.25 inch	ED555/4DS	OST
4	4	4	4	JMP1, JMP2, JMP4, JMP5	PEC02SAAN	Header, Male 2-pin, 100mil spacing,	0.100 inch x 2	PEC02SAAN	Sullins
1	1	1	1	JMP3	PEC03SAAN	Header, Male 3-pin, 100mil spacing,	0.100 inch x 3	PEC03SAAN	Sullins
1	1	1	1	R1	665	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	0	1	0	R11	50k	Potentiometer, 3/8 Cermet, Single-Turn	0.25x0.17 inch	3266W-503-LF	Bourns
0	1	0	1	R11	500k	Potentiometer, 3/8 Cermet, Single-Turn	0.25x0.17 inch	3266W-504-LF	Bourns
2	2	2	2	R2, R4	10k	Potentiometer, 3/8 Cermet, Single-Turn	0.25x0.17 inch	3266W-103-LF	Bourns
2	2	2	2	R3, R12	1.0k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
2	2	2	2	R5, R9	1.5k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
0	0	0	0	R6, R13, R14		Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	1	1	1	R7	10k	Resistor, Chip, 1/16W, 1%	0603	Std	Std
2	2	2	2	R8, R10	0	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	0	0	0	U1	BQ24090DGQ	IC, 800mA, Single-Input, Single Cell Li-Ion BATTERY CHARGER	HTSSOP	BQ24090DGQ	TI
0	1	0	0	U1	BQ24091DGQ	IC, 800mA, Single-Input, Single Cell Li-Ion BATTERY CHARGER	HTSSOP	BQ24091DGQ	TI
0	0	1	0	U1	BQ24092DGQ	IC, 800mA, Single-Input, Single Cell Li-Ion BATTERY CHARGER	HTSSOP	BQ24092DGQ	TI
0	0	0	1	U1	BQ24093DGQ	IC, 800mA, Single-Input, Single Cell Li-Ion BATTERY CHARGER	HTSSOP	BQ24093DGQ	TI
5	5	5	5	Shunt (Note 5)		Shunt, 100-mil, Black	0.1	929950-00	3M
1	1	1	1	-		PCB, 3 In x 1.85 In x 0.0031 In		HPA506	Any

- Notes: 1. These assemblies are ESD sensitive, ESD precautions shall be observed.  
 2. These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.  
 3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.  
 4. Ref designators marked with an asterisk (\*\*\*) cannot be substituted. All other components can be substituted with equivalent MFG's components.  
 5. Apply shunt to JMP1/2/4/5 and JMP3:2/3.

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### EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the power supply voltage range of 4.45 V and 6.45 V. Input voltage range is specified for normal operation. Input voltage between UVLO and 4.75 V has limited functionality, but does not damage the IC nor present any safety issue with the battery. Input voltage above OVP and less than 30 Vdc has no operation and will not damage the IC. Lower input voltage (closer to dropout operation) produces less heat dissipation and potentially better performance.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 60°C. The EVM is designed to operate properly with certain components above 60°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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